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July 2015

MOC256M 8-pin SOIC AC Input Phototransistor Output Optocoupler

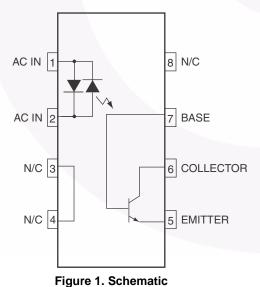
Features

- Bidirectional AC Input
 - Protection Against Reversed DC Bias
- Guaranteed CTR Symmetry of 2:1 Maximum
- Convenient Plastic SOIC-8 Surface Mountable Package Style, with 0.050" Lead Spacing
- Safety and Regulatory Approvals:
 - UL1577, 2,500 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 565 V Peak Working Insulation Voltage

Description

The MOC256M is an AC input phototransistor optocoupler. The device consists of two infrared emitters connected in anti-parallel and coupled to a silicon NPN phototransistor detector. It is designed for applications requiring the detection or monitoring of AC signals. The device is constructed with a standard SOIC-8 footprint.

Schematic



Package Outline

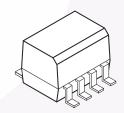


Figure 2. Package Outline

Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

| Parameter | | Characteristics |
|--|------------------------|-----------------|
| Installation Classifications per DIN VDE | < 150 V _{RMS} | I–IV |
| 0110/1.89 Table 1, For Rated Mains Voltage | < 300 V _{RMS} | I–III |
| Climatic Classification | | 55/100/21 |
| Pollution Degree (DIN VDE 0110/1.89) | | 2 |
| Comparative Tracking Index | | 175 |

| Symbol | Parameter | Value | Unit |
|-----------------------|--|-------------------|-------------------|
| V | Input-to-Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test with $t_m = 10$ s, Partial Discharge < 5 pC | 904 | V _{peak} |
| V _{PR} | Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC | 1060 | V _{peak} |
| V _{IORM} | Maximum Working Insulation Voltage | 565 | V _{peak} |
| V _{IOTM} | Highest Allowable Over-Voltage | 4000 | V _{peak} |
| | External Creepage | ≥ 4 | mm |
| | External Clearance | ≥ 4 | mm |
| DTI | Distance Through Insulation (Insulation Thickness) | ≥ 0.4 | mm |
| T _S | Case Temperature ⁽¹⁾ | 150 | °C |
| I _{S,INPUT} | Input Current ⁽¹⁾ | 200 | mA |
| P _{S,OUTPUT} | Output Power ⁽¹⁾ | 300 | mW |
| R _{IO} | Insulation Resistance at T _S , V _{IO} = 500 V ⁽¹⁾ | > 10 ⁹ | Ω |

Note:

1. Safety limit values – maximum values allowed in the event of a failure.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A = 25^{\circ}$ C unless otherwise specified.

| Symbol | Rating | Value | Unit |
|---------------------|--|--------------------|-------|
| TOTAL DEVI | ICE | | |
| T _{STG} | Storage Temperature | -40 to +125 | °C |
| T _A | Ambient Operating Temperature | -40 to +100 | °C |
| T _J | Junction Temperature | -40 to +125 | °C |
| T _{SOL} | Lead Solder Temperature | 260 for 10 seconds | °C |
| Ъ | Total Device Power Dissipation @ T _A = 25°C | 240 | mW |
| P_{D} | Derate Above 25°C | 2.94 | mW/°C |
| EMITTER | | | |
| I _F | Continuous Forward Current | 60 | mA |
| I _F (pk) | Forward Current – Peak (PW = 100 µs, 120 pps) | 1.0 | Α |
| V_{R} | Reverse Voltage | 6.0 | V |
| _ | LED Power Dissipation @ T _A = 25°C | 90 | mW |
| P_{D} | Derate Above 25°C | 0.8 | mW/°C |
| DETECTOR | | | |
| I _C | Continuous Collector Current | 150 | mA |
| V _{CEO} | Collector-Emitter Voltage | 30 | V |
| V _{CBO} | Collector-Base Voltage | 70 | V |
| V _{ECO} | Emitter-Collector Voltage | 7 | V |
| | Detector Power Dissipation @ T _A = 25°C | 150 | mW |
| P_{D} | Derate Above 25°C | 1.76 | mW/°C |

Electrical Characteristics

 $T_A = 25$ °C unless otherwise specified.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|-----------------------|---|--|------|------|------|------|
| EMITTER | | | l | | | |
| V _F | Input Forward Voltage | I _F = ±10 mA | | 1.2 | 1.5 | V |
| C _{IN} | Input Capacitance | V = 0 V, f = 1 MHz | | 20 | | pF |
| DETECTO | R | | | | | |
| I _{CEO1} | Collector-Emitter Dark Current | V _{CE} = 10 V, T _A = 25°C | | 1.0 | 100 | nA |
| I _{CEO2} | Collector-Emitter Dark Current | V _{CE} = 10 V, T _A = 100°C | | 1.0 | | μΑ |
| I _{CBO} | Collector-Base Dark Current | V _{CB} = 10 V | | 0.2 | | nA |
| BV _{CEO} | Collector-Emitter Breakdown Voltage | I _C = 10 mA | 30 | 100 | | nA |
| BV _{CBO} | Collector-Base Breakdown Voltage | I _C = 100 μA | 70 | 120 | | V |
| BV _{ECO} | Emitter-Collector Breakdown Voltage | Ι _Ε = 100 μΑ | 5 | 10 | | V |
| C _{CE} | Collector-Emitter Capacitance | f = 1.0 MHz, V _{CE} = 0 | | 7 | | pF |
| C _{CB} | Collector-Base Capacitance | f = 1.0 MHz, V _{CB} = 0 | | 20 | | pF |
| C _{EB} | Emitter-Base Capacitance | f = 1.0 MHz, V _{EB} = 0 | | 10 | | pF |
| COUPLED | | | | | | |
| CTR | Current Transfer Ratio | $I_F = \pm 10 \text{ mA}, V_{CE} = 10 \text{ V}$ | 20 | 150 | | % |
| | Output-Collector Current Symmetry | $\left(\frac{I_{C} @ I_{F} = +10 \text{ mA, V}_{CE} = 10 \text{ V}}{I_{C} @ I_{F} = -10 \text{ mA, V}_{CE} = 10 \text{ V}}\right)$ | 0.5 | | 2.0 | |
| V _{CE (SAT)} | Collector-Emitter Saturation Voltage | $I_C = 0.5 \text{ mA}, I_F = \pm 10 \text{ mA}$ | | 0.1 | 0.4 | V |

Isolation Characteristics

| Symbol | Characteristic | Test Conditions | Min. | Тур. | Max. | Unit |
|------------------|--------------------------------|---|------------------|------|------|--------------------|
| V _{ISO} | Input-Output Isolation Voltage | t = 1 Minute | 2500 | | | VAC _{RMS} |
| C _{ISO} | Isolation Capacitance | $V_{I-O} = 0 V$, $f = 1 MHz$ | | 0.2 | | pF |
| R _{ISO} | Isolation Resistance | $V_{I-O} = \pm 500 \text{ VDC}, T_A = 25^{\circ}\text{C}$ | 10 ¹¹ | | | Ω |

Typical Performance Curves

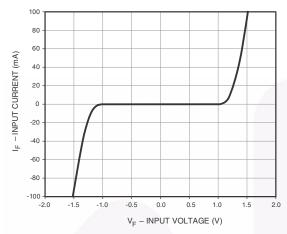


Figure 3. Input Current vs. Input Voltage

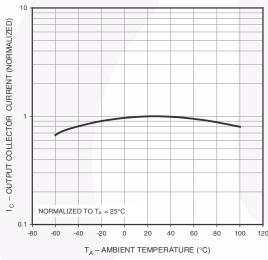


Figure 5. Output Current vs. Ambient Temperature

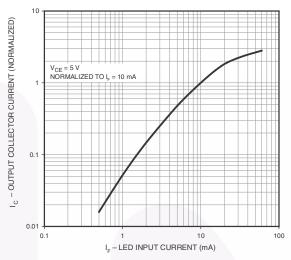


Figure 4. Output Curent vs. Input Current

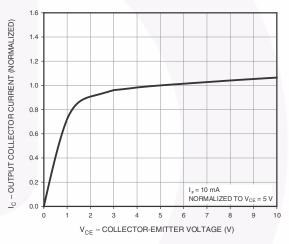


Figure 6. Output Current vs. Collector-Emitter Voltage

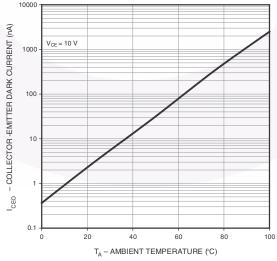


Figure 7. Dark Current vs. Ambient Temperature

Reflow Profile

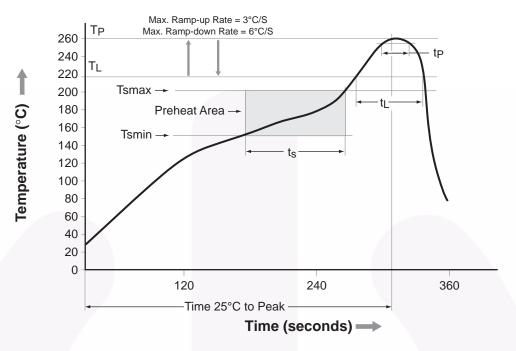


Figure 8. Reflow Profile

| Profile Freature | Pb-Free Assembly Profile | | |
|---|--------------------------|--|--|
| Temperature Minimum (Tsmin) | 150°C | | |
| Temperature Maximum (Tsmax) | 200°C | | |
| Time (t _S) from (Tsmin to Tsmax) | 60-120 seconds | | |
| Ramp-up Rate (t _L to t _P) | 3°C/second maximum | | |
| Liquidous Temperature (T _L) | 217°C | | |
| Time (t _L) Maintained Above (T _L) | 60-150 seconds | | |
| Peak Body Package Temperature | 260°C +0°C / -5°C | | |
| Time (t _P) within 5°C of 260°C | 30 seconds | | |
| Ramp-down Rate (T _P to T _L) | 6°C/second maximum | | |
| Time 25°C to Peak Temperature | 8 minutes maximum | | |

Ordering Information

| Part Number | Package | Packing Method |
|-------------|---|----------------------------|
| MOC256M | Small Outline 8-Pin | Tube (100 Units) |
| MOC256R2M | Small Outline 8-Pin | Tape and Reel (2500 Units) |
| MOC256VM | Small Outline 8-Pin, DIN EN/IEC60747-5-5 Option | Tube (100 Units) |
| MOC256R2VM | Small Outline 8-Pin, DIN EN/IEC60747-5-5 Option | Tape and Reel (2500 Units) |

Marking Information

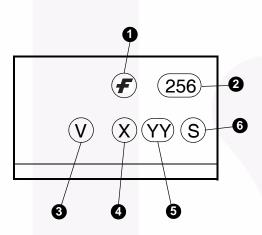
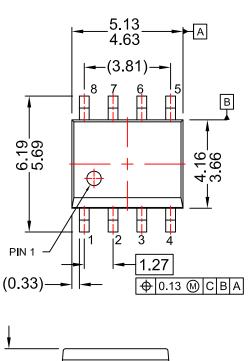
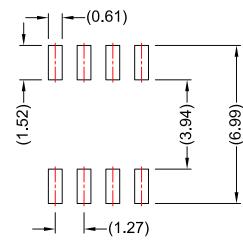


Figure 9. Top Mark

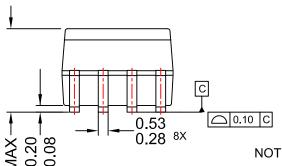
Table 1. Top Mark Definitions

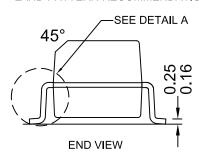
| 1 | Fairchild Logo |
|---|---|
| 2 | Device Number |
| 3 | DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option) |
| 4 | One-Digit Year Code, e.g., "4" |
| 5 | Digit Work Week, Ranging from "01" to "53" |
| 6 | Assembly Package Code |





LAND PATTERN RECOMMENDATION



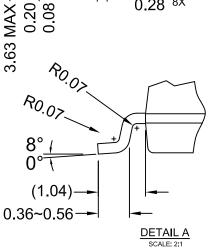






- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M.
- E) DRAWING FILENAME: MKT-M08Erev5





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